

Intel® Atom™ Processor Z3600 and Z3700 Series

Specification Update

May 2015

Revision 009



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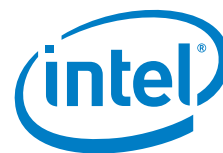
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Revision History

Document Number	Revision Number	Description	Revision Date
329475	001	<ul style="list-style-type: none"> Initial release 	September 2013
329475	002	<ul style="list-style-type: none"> Changed title of the Specification Update collateral Added SKUs Added B-3 stepping errata Errata <ul style="list-style-type: none"> Changed Status of VLT5, VLT6, VLT39, VLT43, VLT44, VLT45 Added VLT46-VLT57. 	November 2013
329475	003	<ul style="list-style-type: none"> Errata <ul style="list-style-type: none"> Added VLT58-VLT64 	January 2014
329475	004	<ul style="list-style-type: none"> Changed the title of the Specification Update collateral Added SKUs: Z3745, Z3745D, Z3735D, Z3735E, Z3795, Z3775, Z3775D, Z3735G, Z3735F. Added C-0 stepping Errata <ul style="list-style-type: none"> Changed Status of VLT6, VLT39, VLT43, VLT44, VLT45 Added VLT65-VLT68 	May 2014
329475	005	<ul style="list-style-type: none"> Added SKU: Z3785, Z3736F, Z3736G. Errata <ul style="list-style-type: none"> Added VLT69-VLT76 Specification Clarifications <ul style="list-style-type: none"> Added VLT1 	September 2014
329475	006	<ul style="list-style-type: none"> No change 	December 2014
329475	007	<ul style="list-style-type: none"> Added SKU: Z3785, Z3736F, Z3736G. Errata <ul style="list-style-type: none"> Added VLT77-VLT79 	January 2015
329475	008	<ul style="list-style-type: none"> Errata <ul style="list-style-type: none"> Added VLT80-VLT81 	February 2015
329475	009	<ul style="list-style-type: none"> Errata <ul style="list-style-type: none"> Added VLT82-VLT83 	May 2015

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Preface

This document is an update to the specifications contained in the documents listed in the following Affected Documents table. It is a compilation of device and document errata and specification clarifications and changes, and is intended for hardware system manufacturers and for software developers of applications, operating system, and tools.

Information types defined in the Nomenclature section of this document are consolidated into this document and are no longer published in other documents. This document may also contain information that has not been previously published.

Note: Throughout this document Intel® Atom™ Processor Z3600 and Z3700 Series SoC is referred as Processor or SoC.

Affected Documents

Document Title	Document Number ¹
Intel® Atom™ Processor Z3600 and Z3700 Series Datasheet (Volume 1 of 2)	329474
Intel® Atom™ Processor Z3600 and Z3700 Series Datasheet (Volume 2 of 2)	329518

NOTE: ¹ Contact local Intel representative for the latest document number.

Related Documents

Please refer to the following documents which may be beneficial when reading this document or for additional information:

Document	Document Number
<i>Intel® 64 and IA-32 Architectures Software Developer's Manuals</i> <ul style="list-style-type: none"> • Volume 1: Basic Architecture • Volume 2A: Instruction Set Reference, A-M • Volume 2B: Instruction Set Reference, N-Z • Volume 3A: System Programming Guide • Volume 3B: System Programming Guide 	http://www.intel.com/products/processor/manuals/index.htm



Document	Document Number
Intel® 64 and IA-32 Architectures Software Developer's Manual Documentation Changes	http://www.intel.com/content/www/us/en/architecture-and-technology/64-ia-32-architectures-software-developers-manual.html

Nomenclature

Errata are design defects or errors in engineering samples. Errata may cause the processor behavior to deviate from published specifications. Hardware and software designed to be used with any given stepping assumes that all errata documented for that stepping are present on all devices.

S-Spec Number is a five-digit code used to identify products. Products are differentiated by their unique characteristics, that is, core speed, L2 cache size, and package type as described in the processor identification information table. Read all notes associated with each S-Spec number.

Specification Changes are modifications to the current published specifications. These changes will be incorporated in any new release of the specification.

Specification Clarifications describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in any new release of the specification.

Documentation Changes include typos, errors, or omissions from the current published specifications. These will be incorporated in any new release of the specification.

Note: Errata remain in the specification update throughout the product's lifecycle, or until a particular stepping is no longer commercially available. Under these circumstances, errata removed from the specification update are archived and available upon request. Specification changes, specification clarifications, and documentation changes are removed from the specification update when the appropriate changes are made to the appropriate product specification or user documentation (datasheets, manuals, and so forth).



Summary Tables of Changes

The following table indicates the Specification Changes, Errata, Specification Clarifications, or Documentation Changes, which apply to the listed steppings. Intel intends to fix some of the errata in a future stepping of the component, and to account for the other outstanding issues through documentation or Specification Changes as noted. This table uses the following notations:

Codes Used in Summary Table

Stepping

X: Erratum, Specification Change or Clarification that applies to this stepping.

(No mark) or (Blank Box): This erratum is fixed in listed stepping or specification change does not apply to list stepping.

Status

Doc: Document change or update that will be implemented.

Plan Fix: This erratum may be fixed in a future stepping of the product.

Fixed: This erratum has been previously fixed.

No Fix: There is no plan to fix this erratum.

Row

Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT1	X	X	X	No Fix	Accessing Unimplemented ISP MMIO Space May Cause a System Hang
VLT2	X	X	X	No Fix	Quad Word Transactions in Violation of Programming Model May Result in System Hang
VLT3	X	X	X	No Fix	GPIO Registers Do Not Support 8 or 16-bit Transactions



Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT4	X	X	X	No Fix	CSI Interface May Not Correct Certain Single-bit Errors
VLT5	X	-	-	Fixed	ULPI Bus Marginality for USB Device Mode
VLT6	X	X	-	Fixed	Anomalies in USB xHCI PME Enable and PME Status
VLT7	X	X	X	No Fix	eMMC Asynchronous Abort May Cause a Hang
VLT8	X	X	X	No Fix	SD Host Controller Incorrectly Reports Supporting of Suspend/ Resume Feature
VLT9	X	X	X	No Fix	SD Host Controller Error Status Registers May be Incorrectly Set
VLT10	X	X	X	No Fix	SD Host Controller Registers Are Not Cleared by Software Reset
VLT11	X	X	X	No Fix	Timing Specification Violation on SD Card Interface
VLT12	X	X	X	No Fix	SD Card Controller Does Not Disable Clock During Card Power Down
VLT13	X	X	X	No Fix	Reset Sequence May Take longer Than Expected When ACG is Enabled in SD And SDIO Controllers
VLT14	X	X	X	No Fix	xHCI Port Assigned Highest SlotID When Resuming From Sx Issue
VLT15	X	X	X	No Fix	LFPS Detect Threshold
VLT16	X	X	X	No Fix	Set Latency Tolerance Value Command Completion Event Issue
VLT17	X	X	X	No Fix	xHCI Data Packet Header and Payload Mismatch Error Condition
VLT18	X	X	X	No Fix	USB xHCI SuperSpeed Packet with Invalid Type Field Issue



Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT19	X	X	X	No Fix	USB xHCI Behaviour with Three Consecutive Failed U3 Entry Attempts
VLT20	X	X	X	No Fix	USB xHCI Max Packet Size and Transfer Descriptor Length Mismatch
VLT21	X	X	X	No Fix	USB EHCI RMH Port Disabled Due to Device Initiated Remote Wake
VLT22	X	X	X	No Fix	USB EHCI Isoch In Transfer Error Issue
VLT23	X	X	X	No Fix	USB EHCI Babble Detected with SW Overscheduling
VLT24	X	X	X	No Fix	USB EHCI Full-/low-speed EOP Issue
VLT25	X	X	X	No Fix	USB EHCI Asynchronous Retries Prioritized Over Periodic Transfers
VLT26	X	X	X	No Fix	USB EHCI FS/LS Incorrect Number of Retries
VLT27	X	X	X	No Fix	USB EHCI RMH Think Time Issue
VLT28	X	X	X	No Fix	USB EHCI Full-/low-speed Device Removal Issue
VLT29	X	X	X	No Fix	Reported Memory Type May Not Be Used to Access the VMCS and Referenced Data Structures
VLT30	X	X	X	No Fix	A Page Fault May Not be Generated When the PS bit is set to "1" in a PML4E or PDPTE
VLT31	X	X	X	No Fix	CS Limit Violations May Not be Detected After VM Entry
VLT32	X	X	X	No Fix	IA32_DEBUGCTL.FREEZE_PERFMON_ON_PMI is Incorrectly Cleared by SMI
VLT33	X	X	X	No Fix	PEBS Record EventingIP Field May be Incorrect After CS.Base Change



Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT34	X	X	X	No Fix	Some Performance Counter Overflows May Not be Logged in IA32_PERF_GLOBAL_STATUS When FREEZE_PERFMON_ON_PMI is Enabled
VLT35	X	X	X	No Fix	MOVNTDQA From WC Memory May Pass Earlier Locked Instructions
VLT36	X	X	X	No Fix	Unsynchronized Cross-Modifying Code Operations Can Cause Unexpected Instruction Execution Results
VLT37	X	X	X	No Fix	SDIO Host Controller Does Not Control the SDIO Bus Power
VLT38	X	X	X	No Fix	USB HSIC Ports Incorrectly Reported as Removable
VLT39	X	X	-	Fixed	Multiple Threads That Access the ISP Concurrently May Lead to a System Hang
VLT40	X	X	X	No Fix	Premature Asynchronous Interrupt Enabling May Lead to Loss of SDIO Wi-Fi Functionality
VLT41	X	X	X	No Fix	Paging Structure Entry May be Used Before Accessed And Dirty Flags Are Updated
VLT42	X	X	X	No Fix	Certain eMMC Host Controller Registers Are Not Cleared by Software Reset
VLT43	X	X	-	Fixed	The Display May Flicker After an MIPI-DSI LP to HS Transition
VLT44	X	X	-	Fixed	LPDDR3 Power-Up Timing
VLT45	X	X	-	Fixed	Using MIPI DSI in LP Mode May Result in Unpredictable Display Behavior
VLT46		X	X	No Fix	USB Device Mode Controller May Not Successfully Switch to High Speed Data Rate



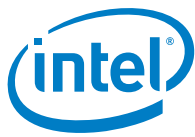
Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT47		X	X	No Fix	USB Device Mode Controller Response Time May Exceed The Specification
VLT48		X	X	No Fix	USB Device Mode Controller May Not Enter the SS.Inactive State
VLT49		X	X	No Fix	USB EHCI Full-/Low-speed Port Reset or Clear TT Buffer Request
VLT50		X	X	No Fix	USB Device Mode Controller LFPS Transmission Period Does Not Meet USB3.0 Specification
VLT51	X	X	X	No Fix	Performance Monitor Instructions Retired Event May Not Count Consistently
VLT52	X	X	X	No Fix	MTF VM Exit May be Delayed Following a VM Entry That Injects a Software Interrupt
VLT53	X	X	X	No Fix	LBR Stack And Performance Counter Freeze on PMI May Not Function Correctly
VLT54	X	X	X	No Fix	USB Legacy Support SMI Not Available from xHCI Controller
VLT55	X	X	X	No Fix	SD Card UHS-I Mode is Not Fully Supported
VLT56	X	X	X	No Fix	EOI Transactions May Not be Sent if Software Enters Core C6 During an Interrupt Service Routine
VLT57	X	X	X	No Fix	USB xHCI May Execute a Stale Transfer Request Block (TRB)
VLT58	X	X	X	No Fix	Certain MIPI CSI Sensors May Not Operate Correctly At Low Clock Frequencies
VLT59	X	X	X	No Fix	SD Card Initialization Sequence May Fail When ACG is Enabled in SD Controller
VLT60	X	X	X	No Fix	Reset Sequence May Not Complete Under Certain Conditions



Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT61	X	X	X	No Fix	Multiple Drivers That Access the GPIO Registers Concurrently May Result in Unpredictable System Behavior
VLT62	X	X	X	No Fix	Boot May Not Complete When SMI Occurs during Boot
VLT63	X	X	X	No Fix	Interrupts That Target an APIC That is Being Disabled May Result in a System Hang
VLT64	X	X	X	No Fix	Corrected or Uncorrected L2 Cache Machine Check Errors May Log Incorrect Address in IA32_MCI_ADDR
VLT65	X	X	X	No Fix	Software-initiated Partition Reset May Cause a System Hang
VLT66	X	X	X	No Fix	Write-1-Clear Bits in PMC Registers May be Unexpectedly Cleared
VLT67	X	X	X	No Fix	Port Reset on USB2 Port0 And Port1 May Cause a Reset on HSIC Port0 and Port1 Respectively
VLT68	X	X	X	No Fix	Frequency Reported by CPUID Instruction May Not Match Published Frequency
VLT69	X	X	X	No Fix	Machine Check Status Overflow Bit May Not be Set
VLT70	X	X	X	No Fix	Attempts to Clear Performance Counter Overflow Bits May Not Succeed
VLT71	X	X	X	No Fix	SMI in 64 Bit Mode May Store an Incorrect RIP to SMRAM When CS has a Non-Zero Base
VLT72	X	X	X	No Fix	VM Exit May Set IA32_EFER.NXE When IA32_MISC_ENABLE Bit 34 is Set to 1
VLT73	X	X	X	No Fix	Top Swap Mechanism May Become Incorrectly Configured



Number	Stepping			Status	Errata Title
	B-2	B-3	C-0		
VLT74	X	X	X	No Fix	Certain Peripheral I/O Controllers May Hang After an Unexpectedly Long Latency Memory Transaction
VLT75	X	X	X	No Fix	Disabling SDIO or SDCARD May Lead To a System Hang
VLT76	X	X	X	No Fix	System May Hang When Attempting to Exit an S0ix Idle State
VLT77	X	X	X	No Fix	TLB Entries May Not Be Invalidated Properly When Bit 8 Is Set in EPT Paging-Structure Entries
VLT78	X	X	X	No Fix	System May Hang During Entry to S0ix
VLT79	X	X	X	No Fix	CPUID Instruction Leaf 0AH May Return an Unexpected Value
VLT80	X	X	X	No Fix	VM Exits During Execution of INTn in Virtual-8086 Mode with Virtual-Mode Extensions May Save RFLAGS Incorrectly
VLT81	X	X	X	No Fix	Clearing IA32_MCO_CTL[5] May Prevent Machine Check Notification
VLT82	X	X	X	No Fix	System May Unexpectedly Reboot After Shutdown
VLT83	X	X	X	No Fix	APIC Timer Interrupt May Not Wake The System From CS



Number	Specification Changes
	None

Number	Specification Clarifications
VLT1	Top Swap Feature

Number	Documentation Changes
	None

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Identification Information

Intel® Atom™ Processor Z3600 and Z3700 Series samples on 22-nm process processor signature can be identified by the following registers contents:

Table 1. Processor Signature by Using the Programming Interface

Reserved	Extended Family ¹	Extended Model ²	Reserved	Processor Type ³	Family Code ⁴	Model Number ⁵	Stepping ID ⁶
31:28	27:20	19:16	15:13	12	11:8	7:4	3:0
0000	00000000b	0011b	000b	0b	0110b	0111b	1000b

NOTES:

1. The Extended Family, Bits [27:20] are used in conjunction with the Family Code, specified in Bits [11:8], to indicate whether the processor belongs to the Intel386™, Intel486™, Pentium®, Pentium® Pro, Pentium® 4, Intel® Core™2, or Intel® Atom™ processor series.
2. The Extended Model, Bits [19:16] in conjunction with the Model Number, specified in Bits [7:4], are used to identify the model of the processor within the processor's family.
3. The Processor Type, specified in Bits [13:12] indicates whether the processor is an original OEM processor, an OverDrive processor, or a dual processor (capable of being used in a dual processor system).
4. The Family Code corresponds to Bits [11:8] of the EDX register after RESET, Bits [11:8] of the EAX register after the CPUID instruction is executed with a 1 in the EAX register, and the generation field of the Device ID register is accessible through Boundary Scan.
5. The Model Number corresponds to Bits [7:4] of the EDX register after RESET, Bits [7:4] of the EAX register after the CPUID instruction is executed with a 1 in the EAX register, and the model field of the Device ID register is accessible through Boundary Scan.
6. The Stepping ID in Bits [3:0] indicates the revision number of that model.

When EAX is initialized to a value of 1, the CPUID instruction returns the Extended Family, Extended Model, Type, Family, Model and Stepping value in the EAX register.

Note: The EDX processor signature value after reset is equivalent to the processor signature output value in the EAX register.



Table 2. Identification Table for Intel® Atom™ Processor Z3600 and Z3700 Series

S-Spec	Stepping	Processor Number	Core Speed			Memory Frequency	Integrated Graphics Core Speed		H-DID/ H-RID1	G-DID/ G-RID2
			Burst Frequency Mode (BFM)	High Frequency Mode (HFM)	Low Frequency Mode (LFM)		Burst Frequency	Base Frequency		
SR1M3	B-2	Z3770	2.4 GHz	1.46 GHz	532 MHz	LPDDR3 - 1067MT/s	667 MHz	311 MHz	0F00h/09h	0F31h/09h
SR1M5	B-2	Z3740	1.8 GHz	1.33 GHz	532 MHz	LPDDR3 - 1067MT/s	667 MHz	311 MHz	0F00h/09h	0F31h/09h
SR1M7	B-2	Z3770D	2.4 GHz	1.5 GHz	500 MHz	DDR3L-RS - 1333MT/s	688 MHz	313 MHz	0F00h/09h	0F31h/09h
SR1M9	B-2	Z3740D	1.83 GHz	1.33 GHz	500 MHz	DDR3L-RS - 1333MT/s	688 MHz	313 MHz	0F00h/09h	0F31h/09h
SR1RU	B-3	Z3770	2.39 GHz	1.46 GHz	532 MHz	LPDDR3 - 1067 MT/s	667 MHz	311 MHz	0F00h/0Bh	0F31h/0Bh
SR1RW	B-3	Z3740	1.86 GHz	1.33 GHz	532 MHz	LPDDR3 - 1067 MT/s	667 MHz	311 MHz	0F00h/0Bh	0F31h/0Bh
SR1S2	B-3	Z3680	2.0 GHz	1.33 GHz	532 MHz	LPDDR3 - 1067 MT/s	667 MHz	311 MHz	0F00h/0Bh	0F31h/0Bh
SR1RY	B-3	Z3770D	2.4 GHz	1.5 GHz	500 MHz	DDR3L-RS - 1333MT/s	688 MHz	313 MHz	0F00h/0Bh	0F31h/0Bh
SR1S0	B-3	Z3740D	1.83 GHz	1.33 GHz	500 MHz	DDR3L-RS - 1333MT/s	688 MHz	313 MHz	0F00h/0Bh	0F31h/0Bh
SR1S4	B-3	Z3680D	2.0 GHz	1.33 GHz	500 MHz	DDR3L-RS - 1333MT/s	688 MHz	313 MHz	0F00h/0Bh	0F31h/0Bh
SR1SP	C-0	Z3745	1.86 GHz	1.33 GHz	532 MHz	LPDDR3 - 1067MT/s	778 MHz	311 MHz	0F00h/0Dh	0F31h/0Dh
SR1ST	C-0	Z3745D	1.83Ghz	1.33 GHz	500MHz	DDR3L-RS - 1333MT/s	792 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR1U7	C-0	Z3735D	1.83Ghz	1.33 GHz	500MHz	DDR3L-RS - 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR1U9	C-0	Z3735E	1.83Ghz	1.33 GHz	500MHz	DDR3L-RS - 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR1SK	C-0	Z3795	2.39 GHz	1.66 GHz	532 MHz	LPDDR3 - 1067MT/s	778 MHz	311 MHz	0F00h/0Dh	0F31h/0Dh
SR1SM	C-0	Z3775	2.39 GHz	1.46 GHz	532 MHz	LPDDR3 - 1067MT/s	778 MHz	311 MHz	0F00h/0Dh	0F31h/0Dh
SR1SR	C-0	Z3775D	2.416 GHz	1.5 GHz	500 MHz	DDR3L-RS - 1333MT/s	792 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR1UD	C-0	Z3735G	1.83 GHz	1.33 GHz	500 MHz	DDR3L-RS - 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh



S-Spec	Stepping	Processor Number	Core Speed			Memory Frequency	Integrated Graphics Core Speed		H-DID/ H-RID1	G-DID/ G-RID2
			Burst Frequency Mode (BFM)	High Frequency Mode (HFM)	Low Frequency Mode (LFM)		Burst Frequency	Base Frequency		
SR1UB	C-0	Z3735F	1.83 GHz	1.33 GHz	500 MHz	DDR3L-RS – 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR1V9	C-0	Z3785	2.416 GHz	1.5 GHz	500 MHz	LPDDR3 - 1333MT/s	833 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR20D	C-0	Z3736F	2.16 GHz	1.33 GHz	500 MHz	DDR3L-RS – 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh
SR20E	C-0	Z3736G	2.16 GHz	1.33 GHz	500 MHz	DDR3L-RS – 1333MT/s	646 MHz	313 MHz	0F00h/0Dh	0F31h/0Dh

NOTES:

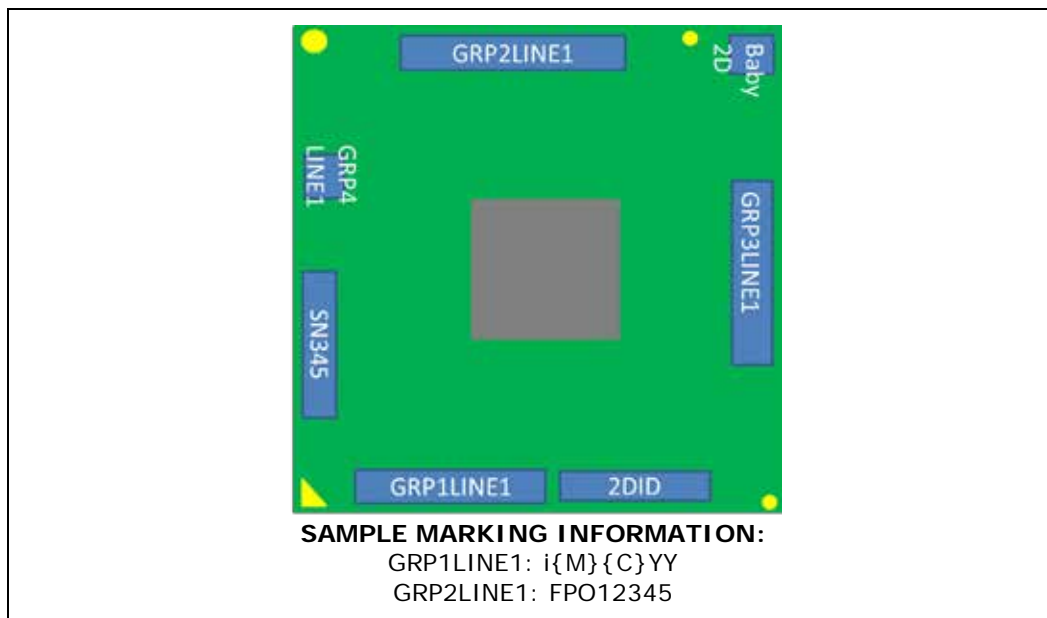
1. H-DID – Host Device ID; H-RID – Host Revision ID (H-RID are last three Bits of H-DID)
2. G-DID – Graphics Device ID; G-RID – Graphics Revision ID (G-RID are last three Bits of G-DID)

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Component Marking Information

Processor shipments can be identified by the following component markings and example pictures.

Figure 1. Intel® Atom™ Processor Z3600 and Z3700 Component Marking Information



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Errata

VLT1 Accessing Unimplemented ISP MMIO Space May Cause a System Hang

Problem: Access to unimplemented ISP (Image Signal Processor) registers should result in a software error. Due to this erratum, the transaction may not complete.

Implication: When this erratum occurs, the system may hang.

Workaround: Do not access unimplemented ISP MMIO space.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT2 Quad Word Transactions in Violation of Programming Model May Result in System Hang

Problem: Quad word (64 bit data) transactions to access two adjacent 32-bit registers of SoC internal devices may cause system hang.

Implication: Due to this erratum, violations of a device programming model may result in a hang instead of a fatal Target Abort / Completer Abort error. Software written in compliance to correct programming model will not be affected.

Workaround: Software must be written and compiled in compliance to correct programming model.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT3 GPIO Registers Do Not Support 8 or 16 bit Transactions

Problem: Due to this erratum, only aligned DWord accesses to GPIO registers function correctly. This erratum applies to GPIO registers whether in MMIO space or IO space.

Implication: GPIO register transactions using byte or word accesses or unaligned DWord accesses will not work correctly.

Workaround: Always use aligned 32 bit transactions when accessing GPIO registers.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT4 CSI Interface May Not Correct Certain Single bit Errors**

Problem: The CSI (Camera Serial Interface) ECC (Error Correcting Code) implementation may not correctly handle single-bit errors in the ECC field and may incorrectly flag as double-bit errors.

Implication: Due to this erratum, some single-bit errors may be treated as double-bit errors. Intel has not observed this erratum with any commercially available software or system.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT5 ULPI Bus Marginality for USB Device Mode

Problem: USB device mode is supported by the SoC via the ULPI (UTMI + Low Pin Interface) bus. The ULPI bus may exhibit read timing marginalities resulting in a hold time violation.

Implication: Due to this erratum, the SoC ULPI reads may be unreliable.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT6 Anomalies in USB xHCI PME Enable and PME Status

Problem: The PME_En (bit 8) and PME_Status (bit 15) in xHCI's PCI PMCSR (Bus 0, Device 20, Function 0, Offset 0x74) do not comply with the PCI specification.

Implication: If a standard bus driver model for this register is applied, wake issues and system slowness may happen.

Workaround: Use Intel-provided BIOS ASL code or refer to Intel-provided xHCI driver reference code.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT7 eMMC Asynchronous Abort May Cause a Hang

Problem: Use of an Asynchronous Abort command to recover from an eMMC transfer error or use of a high priority interrupt STOP_TRANSMISSION command may result in a hang.

Implication: Using Asynchronous Abort command may cause a hang. Intel has not observed this erratum to impact the operation of any commercially available system.

Workaround: The eMMC driver should use High Priority Interrupt SEND_STATUS mode per JEDEC STANDARD eMMC, version 4.5. A minimum wait time of 128us between getting an error interrupt and issuing a software reset will avoid this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT8 SD Host Controller Incorrectly Reports Supporting of Suspend/Resume Feature**

Problem: SDIO, SD Card, and eMMC Controllers should not indicate the support of optional Suspend/Resume feature documented in the SD Host Controller Standard Specification Version 3.0. Due to this erratum, the default value in the Capabilities Register (offset 040H) incorrectly indicates to the software that this feature is supported.

Implication: If software utilizes the Suspend/Resume feature, data may not be correctly transferred between memory and SD device.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT9 SD Host Controller Error Status Registers May be Incorrectly Set

Problem: This erratum impacts SDIO, SD Card, and eMMC SD Host Controllers. Auto CMD Error Status Register (offset 03CH, Bits [7:1]) may be incorrectly set for software-issued commands (for example: CMD13) that generate errors when issued close to the transmission of an Auto CMD12 command. In addition, the Error Interrupt Status Register Bits (offset 032H) are similarly affected.

Implication: Software may not be able to interpret SD Host controller error status.

Workaround: Software should follow the same error recovery flow whenever an error status bit is set. Alternatively, don't use software-issued commands which have Auto CMD12 enabled.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT10 SD Host Controller Registers Are Not Cleared by Software Reset

Problem: This erratum impacts SDIO, SD Card, and eMMC SD Host Controllers. When Software Reset is asserted, registers such as SDMA System Address / Argument 2 (offset 00H) in SD Host Controller are not cleared, failing to comply with the SD Host Controller Specification 3.0.

Implication: Intel has not observed this erratum to impact any commercially available software.

Workaround: Driver is expected to reprogram these registers before issuing a new command.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT11 Timing Specification Violation on SD Card Interface

Problem: SD Card interface IO circuitry is not optimized for platform conditions during operation at 3.3V.

Implication: Due to this erratum, there is an increased risk of a transfer error.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT12 SD Card Controller Does Not Disable Clock during Card Power Down

Problem: The clock and power control of the SD card controller are not linked. Therefore, the SD card controller does not automatically disable the SD card clock when the SD card power is disabled.

Implication: When an SD card is inserted into the system and powered off, the clock to the SD card will continue to be driven. Although this behavior is common, it is a violation of the SD Card Spec 3.0.

Workaround: To address this problem, the SD card clock should be enabled/disabled in conjunction with SD card power.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT13 Reset Sequence May Take Longer Than Expected When ACG is Enabled in SD and SDIO Controllers

Problem: When ACG (Auto Clock Gating) is enabled in SD and SDIO controllers, the reset sequence may take longer than expected, possibly resulting in a software timeout.

Implication: Due to this erratum, a longer response time may be observed after a software-initiated controller reset.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT14 xHCI Port Assigned Highest SlotID When Resuming from Sx Issue

Problem: If a device is attached while the platform is in S3 or S4 and the device is assigned the highest assignable Slot ID upon resume, the xHCI may attempt to access an unassigned main memory address.

Implication: Accessing unassigned main memory address may cause a system software timeout leading to possible system hang.

Workaround: System SW can detect the timeout and perform a host controller reset prior to avoid a system hang.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT15 LFPS Detect Threshold**

Problem: The USB 3.0 host and device controllers' LFPS (Low Frequency Periodic Signal) detect threshold is higher than the USB 3.0 specification maximum of 300 mV.

Implication: The USB 3.0 host and device controllers may not recognize LFPS from SuperSpeed devices transmitting at the minimum low power peak-to-peak differential voltage (400 mV) as defined by USB 3.0 specification for the optional capability for Low-Power swing mode. Intel has not observed this erratum to impact the operation of any commercially available system.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT16 Set Latency Tolerance Value Command Completion Event Issue

Problem: The xHCI controller does not return a value of '0' for slot ID in the command completion event TRB (Transfer Request Block) for a set latency tolerance value command.

Note: This violates the command completion event TRB description in section 6.4.2.2 of the eXtensible Host Controller Interface for Universal Serial Bus (xHCI) specification, revision 1.0.

Implication: There are no known functional failures due to this issue.

Note: Set latency tolerance value command is specific to the controller and not the slot. Software knows which command was issued and which fields are valid to check for the event.

Note: xHCI CV compliance test suite: Test TD4.10: Set Latency Tolerance Value Command Test may issue a warning.

Workaround: None identified

Status: For the steppings affected, see the Summary Tables of Changes.

VLT17 xHCI Data Packet Header and Payload Mismatch Error Condition

Problem: If a SuperSpeed device sends a DPH (Data Packet Header) to the xHCI with a data length field that specifies less data than is actually sent in the DPP (Data Packet Payload), the xHCI will accept the packet instead of discarding the packet as invalid.

Note: The USB 3.0 specification requires a device to send a DPP matching the amount of data specified by the DPH.

Implication: The amount of data specified in the DPH will be accepted by the xHCI and the remaining data will be discarded and may result in anomalous system behavior.

Note: This issue has only been observed in a synthetic test environment with a synthetic device.

Workaround: None identified

Status: For the steppings affected, see the Summary Tables of Changes.

VLT18 USB xHCI SuperSpeed Packet with Invalid Type Field Issue

Problem: If the encoding for the “type” field for a SuperSpeed packet is set to a reserved value and the encoding for the “subtype” field is set to “ACK”, the xHCI may accept the packet as a valid acknowledgement transaction packet instead of ignoring the packet.

Note: The USB 3.0 specification requires that a device never set any defined fields to reserved values.

Implication: System implication is dependent on the misbehaving device and may result in anomalous system behavior.

Note: This issue has only been observed in a synthetic test environment with a synthetic device.

Workaround: None identified

Status: For the steppings affected, see the Summary Tables of Changes.

VLT19 USB xHCI Behavior with Three Consecutive Failed U3 Entry Attempts

Problem: The xHCI does not transition to the SS.Inactive USB 3.0 LTSSM (Link Training and Status State Machine) state after a SuperSpeed device fails to enter U3 upon three consecutive attempts.

Note: The USB 3.0 specification requires a SuperSpeed device to enter U3 when directed.

Implication: The xHCI will continue to try to initiate U3. The implication is driver and operating system dependent.

Workaround: None identified

Status: For the steppings affected, see the Summary Tables of Changes.

VLT20 USB xHCI Max Packet Size and Transfer Descriptor Length Mismatch

Problem: The xHCI may incorrectly handle a request from a low-speed or full-speed device when all the following conditions are true:

- The sum of the packet fragments equals the length specified by the TD (Transfer Descriptor)
- The TD length is less than the MPS (Max Packet Size) for the device
- The last packet received in the transfer is “0” or babble bytes

Implication: The xHCI will halt the endpoint if all the above conditions are met. All functions associated with the endpoint will stop functioning until the device is unplugged and reinserted.

Workaround: None identified

Status: For the steppings affected, see the Summary Tables of Changes.



VLT21 USB EHCI RMH Port Disabled Due to Device Initiated Remote Wake

Problem: During resume from Global Suspend, the RMH controller may not send SOF soon enough to prevent a device from entering suspend again. A collision on the port may occur if a device initiated remote wake occurs before the RMH controller sends SOF.

Note: Intel has only observed this issue when two USB devices on the same RMH controller send remote wake within 30 ms window while RMH controller is resuming from Global Suspend

Implication: The RMH host controller may detect the collision as babble and disable the port.

Workaround: Intel recommends system software to check bit 3 (Port Enable/Disable Change) together with bit 7 (Suspend) of Port N Status and Control PORTC registers when determining which port(s) have initiated remote wake. Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT22 USB EHCI Isoch in Transfer Error Issue

Problem: If a USB full-speed inbound isochronous transaction with a packet length 190 bytes or greater is started near the end of a microframe the SoC may see more than 189 bytes in the next microframe.

Implication: If the SoC sees more than 189 bytes for a microframe an error will be sent to software and the isochronous transfer will be lost. If a single data packet is lost no perceptible impact for the end user is expected.

Note: Intel has only observed the issue in a synthetic test environment where precise control of packet scheduling is available, and has not observed this failure in its compatibility validation testing.

- Isochronous traffic is periodic and cannot be retried thus it is considered good practice for software to schedule isochronous transactions to start at the beginning of a microframe. Known software solutions follow this practice.
- To sensitize the system to the issue additional traffic such as other isochronous transactions or retries of asynchronous transactions would be required to push the inbound isochronous transaction to the end of the microframe.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT23 USB EHCI Babble Detected with SW Overscheduling

Problem: If software violates USB periodic scheduling rules for full-speed isochronous traffic by overscheduling, the RMH may not handle the error condition properly and return a completion split with more data than the length expected.

Implication: If the RMH returns more data than expected, the endpoint will detect packet babble for that transaction and the packet will be dropped. Since overscheduling occurred to create the error condition, the packet would be dropped regardless of RMH behavior.



If a single isochronous data packet is lost, no perceptible impact to the end user is expected.

Note: USB software overscheduling occurs when the amount of data scheduled for a microframe exceeds the maximum budget. This is an error condition that violates the USB periodic scheduling rule.

Note: This failure has only been recreated synthetically with USB software intentionally overscheduling traffic to hit the error condition.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT24 USB EHCI Full-/low-speed EOP Issue

Problem: If the EOP of the last packet in a USB Isochronous split transaction (Transaction >189 bytes) is dropped or delayed 3 ms or longer the following may occur:

- If there are no other pending low-speed or full-speed transactions the RMH will not send SOF, or Keep-Alive. Devices connected to the RMH will interpret this condition as idle and will enter suspend.
- If there is other pending low-speed or full-speed transactions, the RMH will drop the isochronous transaction and resume normal operation.

Implication: If there are no other transactions pending, the RMH is unaware a device has entered suspend and may start sending a transaction without waking the device. The implication is device dependent, but a device may stall and require a reset to resume functionality. If there are other transactions present, only the initial isochronous transaction may be lost. The loss of a single isochronous transaction may not result in end user perceptible impact.

Note: Intel has only observed this failure when using software that does not comply with the USB specification and violates the hardware isochronous scheduling threshold by terminating transactions that are already in progress

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.



VLT25 **USB EHCI Asynchronous Retries Prioritized Over Periodic Transfers**

Problem: The integrated USB RMH incorrectly prioritizes full-speed and low-speed asynchronous retries over dispatchable periodic transfers.

Implication: Periodic transfers may be delayed or aborted. If the asynchronous retry latency causes the periodic transfer to be aborted, the impact varies depending on the nature of periodic transfer:

- If a periodic interrupt transfer is aborted, the data may be recovered by the next instance of the interrupt or the data could be dropped.
- If a periodic isochronous transfer is aborted, the data will be dropped. A single dropped periodic transaction should not be noticeable by end user.

Note: This issue has only been seen in a synthetic environment. The USB spec does not consider the occasional loss of periodic traffic a violation

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT26 **USB EHCI FS/LS Incorrect Number of Retries**

Problem: A USB low-speed transaction may be retried more than three times, and a USB full-speed transaction may be retried less than three times if all of the following conditions are met:

- A USB low-speed transaction with errors or the first retry of the transaction occurs near the end of a microframe, and there is not enough time to complete another retry of the low-speed transaction in the same microframe.
- There is pending USB full-speed traffic and there is enough time left in the microframe to complete one or more attempts of the full-speed transaction.
- Both the low-speed and full-speed transactions must be asynchronous (Bulk/Control) and must have the same direction either in or out.

Note: Per the USB EHCI Specification a transaction with errors should be attempted a maximum of 3 times if it continues to fail.

Implication: For low-speed transactions the extra retry(s) allow a transaction additional chance(s) to recover regardless of if the full-speed transaction has errors or not. If the full-speed transactions also have errors, the SoC may retry the transaction fewer times than required, stalling the device prematurely. Once stalled, the implication is software dependent, but the device may be reset by software.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT27 USB EHCI RMH Think Time Issue**

Problem: The USB RMH Think Time may exceed its declared value in the RMH hub descriptor register of 8 full-speed bit times.

Implication: If the USB driver fully subscribes a USB microframe, LS/FS transactions may exceed the microframe boundary.

Note: No functional failures have been observed.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT28 USB EHCI Full-/low-speed Device Removal Issue

Problem: If two or more USB full-/low-speed devices are connected to the EHCI USB controller, the devices are not suspended, and one device is removed, one or more of the devices remaining in the system may be affected by the disconnect.

Implication: The implication is device dependent. A device may experience a delayed transaction, stall and be recovered via software, or stall and require a reset such as a hot plug to resume normal functionality.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT29 Reported Memory Type May Not Be Used to Access the VMCS and Referenced Data Structures

Problem: Bits 53:50 of the IA32_VMX_BASIC MSR report the memory type that the processor uses to access the VMCS and data structures referenced by pointers in the VMCS. Due to this erratum, a VMX access to the VMCS or referenced data structures will instead use the memory type that the MTRRs (memory-type range registers) specify for the physical address of the access.

Implication: Bits 53:50 of the IA32_VMX_BASIC MSR report that the WB (write-back) memory type will be used but the processor may use a different memory type.

Workaround: Software should ensure that the VMCS and referenced data structures are located at physical addresses that are mapped to WB memory type by the MTRRs.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT30 A Page Fault May Not be Generated When the PS bit is set to “1” in a PML4E or PDPTE**

Problem: On processors supporting Intel® 64 architecture the PS bit (Page Size bit 7) is reserved in PML4Es and PDPTEs. If the translation of the linear address of a memory access encounters a PML4E or a PDPTE with PS set to 1 a page fault should occur. Due to this erratum, PS of such an entry is ignored and no page fault will occur due to its being set.

Implication: Software may not operate properly if it relies on the processor to deliver page faults when reserved Bits are set in paging-structure entries.

Workaround: Software should not set bit 7 in any PML4E or PDPTE that has Present bit (bit 0) set to “1”.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT31 CS Limit Violations May Not be detected after VM Entry

Problem: The processor may fail to detect a CS limit violation on fetching the first instruction after VM entry if the first byte of that instruction is outside the CS limit but the last byte of the instruction is inside the limit.

Implication: The processor may erroneously execute an instruction that should have caused a general protection exception.

Workaround: When a VMM emulates a branch instruction it should inject a general protection exception if the instruction's target EIP is beyond the CS limit.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT32 IA32_DEBUGCTL.FREEZE_PERFMON_ON_PMI is Incorrectly Cleared by SMI

Problem: FREEZE_PERFMON_ON_PMI (bit 12) in the IA32_DEBUGCTL MSR (1D9H) is erroneously cleared during delivery of an SMI (system-management interrupt).

Implication: As a result of this erratum the performance monitoring counters will continue to count after a PMI occurs in SMM (system-management Mode).

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT33 PEBS Record EventingIP Field May be Incorrect after CS.Base Change

Problem: Due to this erratum a PEBS (Precise Event Base Sampling) record generated after an operation which changes CS.Base may contain an incorrect address in the EventingIP field.

Implication: Software attempting to identify the instruction which caused the PEBS event may identify the incorrect instruction when non-zero CS.Base is supported and CS.Base is changed. Intel has not observed this erratum to impact the operation of any commercially available system.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT34 Some Performance Counter Overflows May Not be logged in IA32_PERF_GLOBAL_STATUS When FREEZE_PERFMON_ON_PMI is enabled

Problem: When enabled, FREEZE_PERFMON_ON_PMI bit 12 in IA32_DEBUGCTL MSR (1D9H) freezes PMCs (performance monitoring counters) on a PMI (Performance Monitoring Interrupt) request by clearing the IA32_PERF_GLOBAL_CTRL MSR (38FH). Due to this erratum, when FREEZE_PERFMON_ON_PMI is enabled and two or more PMCs overflow within a small window of time and PMI is requested, then subsequent PMC overflows may not be logged in IA32_PERF_GLOBAL_STATUS MSR (38EH).

Implication: On a PMI, subsequent PMC overflows may not be logged in IA32_PERF_GLOBAL_STATUS MSR.

Workaround: Re-enabling the PMCs in IA32_PERF_GLOBAL_CTRL will log the overflows that were not previously logged in IA32_PERF_GLOBAL_STATUS.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT35 MOVNTDQA from WC Memory May Pass Earlier Locked Instructions

Problem: An execution of MOVNTDQA that loads from WC (write combining) memory may appear to pass an earlier locked instruction to a different cache line.

Implication: Software that expects a lock to fence subsequent MOVNTDQA instructions may not operate properly. If the software does not rely on locked instructions to fence the subsequent execution of MOVNTDQA then this erratum does not apply.

Workaround: Software that requires a locked instruction to fence subsequent executions of MOVNTDQA should insert an LFENCE instruction before the first execution of MOVNTDQA following the locked instruction. If there is already fencing or serializing instruction between the locked instruction and the MOVNTDQA, then an additional LFENCE is not necessary.

Status: For the steppings affected, see the Summary Tables of Changes.



VLT36 Unsynchronized Cross-Modifying Code Operations Can Cause Unexpected Instruction Execution Results

Problem: The act of one processor or system bus master writing data into a currently executing code segment of a second processor with the intent of having the second processor execute that data as code is called cross-modifying code (XMC). XMC that does not force the second processor to execute a synchronizing instruction prior to execution of the new code is called unsynchronized XMC. Software using unsynchronized XMC to modify the instruction byte stream of a processor can see unexpected or unpredictable execution behavior from the processor that is executing the modified code.

Implication: In this case the phrase "unexpected or unpredictable execution behavior" encompasses the generation of most of the exceptions listed in the Intel Architecture Software Developer's Manual Volume 3: System Programming Guide including a General Protection Fault (GPF) or other unexpected behaviors. In the event that unpredictable execution causes a GPF the application executing the unsynchronized XMC operation would be terminated by the operating system.

Workaround: In order to avoid this erratum programmers should use the XMC synchronization algorithm as detailed in the Intel Architecture Software Developer's Manual Volume 3: System Programming Guide Section: Handling Self- and Cross-Modifying Code.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT37 SDIO Host Controller Does Not Control the SDIO Bus Power

Problem: The SD Bus Power bit in Power Control Register (Bus 0; Device 17; Function 0; Offset 029H) is not connected to any SOC IO pin that can reset the SDIO bus power. Due to this erratum, SDIO device Power-On-Reset cannot be controlled by Power Control Register. SDIO Controller may fail to comply with SD Host Controller Specification Version 3.00.

Implication: SDIO devices may not be powered up and initialized correctly.

Workaround: Software should be configured to use a GPIO pin on the platform to enable or disable the SDIO bus power. Please refer to Bay Trail-T SoC External Design Specification (EDS) document.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT38 USB HSIC Ports Incorrectly Reported as Removable

Problem: The DR (Device Removable) bit in the PORTSC registers of the two USB HSIC ports incorrectly indicates that devices on these ports may be removed.

Implication: Software that relies solely on the state of DR bits will consider fixed devices to be removable. This may lead the software to improper actions (e.g. requesting the user remove a fixed device).

Workaround: In conjunction with the DR bits, software should use BIOS-configured ACPI tables and factor in the CONNECTABLE field of the USB Port Capabilities object when determining whether a port is removable.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT39 Multiple Threads That Access the ISP Concurrently May Lead to a System Hang

Problem: The ISP (Image Signal Processor) may not be able to process concurrent accesses.

Implication: If multiple software threads access the ISP concurrently, it may lead to system hang during video recording, still image capture or preview modes.

Workaround: Avoid using multiple threads that may concurrently access the ISP. The Intel-provided drivers implement this workaround.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT40 Premature Asynchronous Interrupt Enabling May Lead to Loss of SDIO Wi-Fi Functionality

Problem: Setting the SDIO controller's Host Control 2 Register Asynchronous Interrupt Enable (Bus 0; Device 17; Function 0; Offset 03EH, bit 14) to '1' before the signal voltage switch sequence completion may result in SDIO card initialization failure.

Implication: SDIO card initialization failure may lead to software time out and loss of Wi-Fi device functionality. Currently released common operating system drivers do not use Asynchronous Interrupt mode.

Workaround: The SDIO driver should either use SDIO Synchronous Interrupt Mode or enable SDIO Asynchronous Interrupt Mode after the SDIO card signal voltage switch sequence completes.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT41 Paging Structure Entry May be Used Before Accessed And Dirty Flags Are Updated

Problem: If software modifies a paging structure entry while the processor is using the entry for linear address translation, the processor may erroneously use the old value of the entry to form a translation in a TLB (or an entry in a paging structure cache) and then update the entry's new value to set the accessed flag or dirty flag. This will occur only if both the old and new values of the entry result in valid translations.

Implication: Incorrect behavior may occur with algorithms that atomically check that the accessed flag or the dirty flag of a paging structure entry is clear and modify other parts of that paging structure entry in a manner that results in a different valid translation.

Workaround: Affected algorithms must ensure that appropriate TLB invalidation is done before assuming that future accesses do not use translations based on the old value of the paging structure entry.

Status: For the steppings affected, see the Summary Tables of Changes.



VLT42 **Certain eMMC Host Controller Registers Are Not Cleared by Software Reset**

Problem: Due to this erratum, when an eMMC Host Controller software reset is requested by setting bit 0 of the Software Reset Register (Offset 2FH), the Command Response Register (Offset 10H) and ADMA Error Status Register (Offset 54H) are not cleared. This does not comply with the SD Host Controller Specification 3.0.

Implication: Intel has not observed this erratum to impact any commercially available software.

Workaround: Software should not read these registers until a response is received from the eMMC device.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT43 **The Display May Flicker After an MIPI-DSI LP to HS Transition**

Problem: Due to this erratum, when the MIPI (Mobile Industry Processor Interface) display PHY switches from LP (low power) mode to HS (high speed) mode, there is a brief interval (50 ns) where the four MIPI DSI (Display Serial Interface) data lanes may not be synchronized.

Implication: The effects are MIPI Panel dependent. Intel has observed display flicker on some MIPI Panels.

Workaround: Workaround for this erratum is panel dependent and can be implemented in firmware or software.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT44 **LPDDR3 Power-Up Timing**

Problem: JEDEC Standard JESD209-3 requires a minimum additional time (denoted by tMRRI) after an "exit from standby, idle power-down mode" before any MRR (Mode Register Read) command can be issued. Due to this erratum, the SoC may not comply with the tMRRI specification.

Implication: Intel has not observed this erratum to impact the functionality or performance of any commercially available LPDDR3 memory parts operating at speeds up to 1067MT/s.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT45 Using MIPI DSI in LP Mode May Result in Unpredictable Display Behavior

Problem: DSI (Display Serial Interface) commands sent in LP (low power) mode to the MIPI (Mobile Industry Processor Interface) DSI controller may fail to execute if the controller is configured to be clocked by the DSI PLL.

Implication: When this erratum occurs, the display panel will behave unpredictably.

Workaround: The display driver can avoid the conditions necessary for this erratum by either using HS (High Speed) mode for sending all DSI commands or selecting PLL Bypass Mode for all LP mode operations and DSI PLL for HS mode. The Intel display drivers implement this workaround.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT46 USB Device Mode Controller May Not Successfully Switch to High Speed Data Rate

Problem: The USB Device Mode Controller may initiate speed change to High Speed data rate immediately following a reset of a discrete ULPI (UTMI+ Low Pin Interface) compliant PHY (physical layer) device.

Implication: Some ULPI-compliant PHYs may not recognize the USB Device Mode Controller speed change and thus may not be able to support USB High Speed operation.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT47 USB Device Mode Controller Response Time May Exceed The Specification

Problem: The USB ULPI specification allocates 112 bit times for the USB Device Mode controller to respond to requests. Due to this erratum, the SoC's Device Mode controller may exceed this specification.

Implication: USB response time may exceed specifications in configurations with maximal total USB cable length, resulting in communication failure.

Workaround: Limit the total cable length used to connect to the host to less than 24m to compensate for the additional controller response time.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT48 USB Device Mode Controller May Not Enter the SS.Inactive State**

Problem: When operating at SuperSpeed rates, the PENDING_HP_TIMER is used to detect lost or corrupted acknowledgements. The USB3.0 specification requires a USB port to transition to the SS.Inactive state on the fourth consecutive timeout. Due to this erratum, the USB device mode controller in device mode will continue to enter Recovery state and not enter the SS.Inactive state.

Implication: This behavior does not comply with the USB3.0 specification. Intel has not observed this erratum to impact the operation of any commercially available system.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT49 USB EHCI Full-/Low-speed Port Reset or Clear TT Buffer Request

Problem: One or more full-/low-speed USB devices on the same RMH controller may be affected if the devices are not suspended and either (a) software issues a Port Reset OR (b) software issues a Clear TT Buffer request to a port executing a split full-/low-speed Asynchronous Out command. The small window of exposure for full-speed device is around 1.5 microseconds and around 12 microseconds for a low-speed device.

Implication: The affected port may stall or receive stale data for a newly arrived split transfer occurring at the time of the Port Reset or Clear TT Buffer request.

Note: This issue has only been observed in a synthetic test environment.

Workaround: Intel recommends the use of the USB xHCI controller which is not affected by this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT50 USB Device Mode Controller LFPS Transmission Period Does Not Meet USB3.0 Specification

Problem: Upon USB Device Mode Controller SuperSpeed U1 (low-power state) exit, the LFPS (Low-Frequency Periodic Signaling) signal may be transmitted for less than the 600ns required by USB3.0 specification.

Implication: In case of concurrent U1 exit by both sides of the USB link, there may be insufficient LFPS duration to ensure the exit is successful. In cases where U1 exit does not succeed, host software will typically initiate link recovery. Intel has not observed this erratum with any commercially available systems.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT51 Performance Monitor Instructions Retired Event May Not Count Consistently

Problem: Performance Monitor Instructions Retired (Event COH; Umask 00H) and the instruction retired fixed counter (IA32_FIXED_CTR0 MSR (309H)) are used to track the number of instructions retired. Due to this erratum, certain situations may cause the counter(s) to increment when no instruction has retired or to not increment when specific instructions have retired.

Implication: A performance counter counting instructions retired may over or under count. The count may not be consistent between multiple executions of the same code.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT52 MTF VM Exit May be Delayed Following a VM Entry That Injects a Software Interrupt

Problem: If the “monitor trap flag” VM-execution control is 1 and VM entry is performing event injection, an MTF VM exit should be delivered immediately after the VM entry. Due to this erratum, delivery of the MTF VM exit may be delayed by one instruction if the event being injected is a software interrupt and if the guest state being loaded has RFLAGS.VM = CR4.VME = 1. In this case, the MTF VM exit is delivered following the first instruction of the software interrupt handler.

Implication: Software using the monitor trap flag to trace guest execution may fail to get a notifying VM exit after injecting a software interrupt. Intel has not observed this erratum with any commercially available system.

Workaround: None identified. An affected virtual-machine monitor could emulate delivery of the software interrupt before VM entry.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT53 LBR Stack And Performance Counter Freeze on PMI May Not Function Correctly

Problem: When FREEZE_LBRS_ON_PMI flag (bit 11) in IA32_DEBUGCTL MSR (1D9H) is set, the LBR (Last Branch Record) stack is frozen on a hardware PMI (Performance Monitoring Interrupt) request. When FREEZE_PERFMON_ON_PMI flag (bit 12) in IA32_DEBUGCTL MSR is set, a PMI request clears each of the ENABLE fields of the IA32_PERF_GLOBAL_CTRL MSR (38FH) to disable counters. Due to this erratum, when FREEZE_LBRS_ON_PMI and/or FREEZE_PERFMON_ON_PMI is set in IA32_DEBUGCTL MSR and the local APIC is disabled or the PMI LVT is masked, the LBR Stack and/or Performance Counters Freeze on PMI may not function correctly.

Implication: Performance monitoring software may not function properly if the LBR Stack and Performance Counters Freeze on PMI do not operate as expected. Intel has not observed this erratum to impact any commercially available system.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT54 USB Legacy Support SMI Not Available from xHCI Controller**

Problem: SMIs are routed using the PMC (Power Management Controller) SMI_STS and SMI_EN registers. However, the USB SMI Enable (USB_SMI_EN) and USB Status (USB_STS) fields only reflect SMIs for the EHCI USB controller. SMIs triggered by the xHCI controller's USBLEGCTLSTS mechanism are not available.

Implication: BIOS is unable to receive SMI interrupts from the xHCI controller. BIOS mechanisms such as legacy keyboard emulation for pre-OS environments will be impacted.

Workaround: Use the EHCI controller when using SMI-based legacy keyboard emulation provided by BIOS.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT55 SD Card UHS-I Mode is Not Fully Supported

Problem: The SD Card Specification rev 3.01 Addendum 1 specifies a relaxed NCRC (Number of clocks to Cyclic Redundancy Check) timing specification for UHS-I (DDR50) mode. Due to this erratum, the SD Host Controller is not fully compatible with this relaxed timing specification.

Implication: Using UHS-I mode with SD devices that rely upon relaxed NCRC may cause SD host commands to fail to complete, resulting in device access failures.

Workaround: BIOS and driver code changes have been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT56 EOI Transactions May Not be Sent if Software Enters Core C6 During an Interrupt Service Routine

Problem: If core C6 is entered after the start of an interrupt service routine but before a write to the APIC EOI (End of Interrupt) register, and the core is woken up by an event other than a fixed interrupt source the core may drop the EOI transaction the next time APIC EOI register is written and further interrupts from the same or lower priority level will be blocked.

Implication: EOI transactions may be lost and interrupts may be blocked when core C6 is used during interrupt service routines.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT57 USB xHCI May Execute a Stale Transfer Request Block (TRB)

Problem: When a USB 3.0 or USB 2.0 hub with numerous active Full-Speed (FS) or Low-Speed (LS) periodic endpoints attached is removed and then reconnected to an USB xHCI port, the xHCI controller may fail to fully refresh its cache of TRB records. The controller may read and execute a stale TRB and place a pointer to it in a Transfer Event TRB.

Implication: In some cases, the xHCI controller may read de-allocated memory pointed to by a TRB of a disabled slot. The xHCI controller may also place a pointer to that memory in

the event ring, causing the xHCI driver to access that memory and process its contents, resulting in system hang, failure to enumerate devices, or other anomalous system behavior.

Note: This issue has only been observed in a stress test environment.

Workaround: None identified.

Note: A BIOS code change to reduce the occurrence of this erratum has been identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT58 **Certain MIPI CSI Sensors May Not Operate Correctly At Low Clock Frequencies**

Problem: MIPI (Mobile Industry Processor Interface) CSI (Camera Serial Interface) DPHY may drop packets if the MIPI CSI clock frequency is below 80MHz and if camera sensor uses THS-Exit less than 200ns.

Implication: Intel has observed this erratum on systems using specific VGA sensors which operate at 80MHz or lower and has THS-Exit less than 200ns.

Workaround: Do not operate sensor below 80MHz MIPI CSI clock with THS-Exit less than 200ns.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT59 **SD Card Initialization Sequence May Fail When ACG is Enabled in SD Controller**

Problem: When ACG (Auto Clock Gating) is enabled in SD controller, SDCLK may get turned off before voltage switch sequence is complete, possibly resulting in an initialization failure.

Implication: Intel has not observed this erratum to impact any commercially available software or system.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT60 **Reset Sequence May Not Complete Under Certain Conditions**

Problem: Under certain conditions, the SoC may not complete initialization either during a reset issued while the system is running or from the G3 (mechanically off) global system state.

Implication: When this erratum occurs, the SoC will detect an initialization problem and halt the initialization sequence prior to normal operation, leading to a system hang. The system will subsequently require a power cycle via the system power button.

Workaround: A firmware workaround has been identified that significantly reduces the likelihood of this erratum for a reset issued while the system is running.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT61 Multiple Drivers That Access the GPIO Registers Concurrently May Result in Unpredictable System Behavior**

Problem: The PCU (Platform Control Unit) in SoC may not be able to process concurrent accesses to the GPIO registers. Due to this erratum, read instructions may return 0xFFFFFFFF and write instructions may be dropped.

Implication: Multiple drivers concurrently accessing GPIO registers may result in unpredictable system behavior.

Workaround: GPIO drivers should not access GPIO registers concurrently. Each driver should acquire a global lock before accessing the GPIO register, and then release the lock after the access is completed. The Intel-provided drivers implement this workaround.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT62 Boot May Not Complete When SMI Occurs during Boot

Problem: During boot, the system should be able to handle SMIs (System Management Interrupt). Due to this erratum, boot may not complete when SMI occurs during boot.

Implication: If the system receives an SMI during boot, the boot may not complete.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT63 Interrupts That Target an APIC That is Being Disabled May Result in a System Hang

Problem: Interrupts that target a Logical Processor whose Local APIC is either in the process of being hardware disabled by clearing bit 11 in the IA32_APIC_BASE_MSR or software disabled by clearing bit 8 in the Spurious-Interrupt Vector Register at offset 0F0H from the APIC base are neither delivered nor discarded.

Implication: When this erratum occurs, the processor may hang.

Workaround: None identified. Software must follow the recommendation that all interrupt sources that target an APIC must be masked or changed to no longer target the APIC, and that any interrupts targeting the APIC be quashed, before the APIC is disabled.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT64 Corrected or Uncorrected L2 Cache Machine Check Errors May Log Incorrect Address in IA32_MCi_ADDR

Problem: For L2 Cache errors with IA32_MCi_STATUS.MCACOD (bits [15:0]) value 0000_0001_0000_1010b, the address reported in IA32_MCi_ADDR MSR may not be the address that caused the machine check.

Implication: Due to this erratum, the address reported in IA32_MCi_ADDR may be incorrect.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT65 Software-initiated Partition Reset May Cause a System Hang

Problem: When the software issues CF9H I/O port host partition reset, the SoC may hang during the reset sequence.

Implication: When this erratum occurs, the system may hang.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT66 Write-1-Clear Bits in PMC Registers May be Unexpectedly Cleared

Problem: Due to this erratum, writing certain PMC (Power Management Controller) registers with 8-bit, 16-bit, or non-naturally aligned 32-bit transfers may cause write-1-clear bits in adjacent fields to be unexpectedly cleared.

The affected registers are: PRSTS, VLV_PM_STS, GEN_PMCON1, S0IX_WAKE_STS, PM1_STS_EN, GPE0a_STS, SMI_STS, ALT_GPIO_SMI, UPRWC, TCO_STS.

Implication: Write-1-clear bits are typically used to report interrupt-type events to software. Inadvertent clearing of these bits may prevent software from detecting events. Intel has not observed this erratum to impact the operation of any commercially available software.

Workaround: The affected registers should be written with naturally aligned 32-bit transfers. When the destination field is narrower than 32 bits, adjacent field(s) within the naturally aligned 32-bit boundary must also be written.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT67 Port Reset on USB2 Port0 And Port1 May Cause a Reset on HSIC Port0 and Port1 Respectively

Problem: HSIC Port0 - Port1 are dedicated to HSIC devices, while USB Port0 – Port3 can be used for USB devices. Due to this erratum, a traffic interrupt is caused on HSIC Port0 or HSIC Port1 when a Port Reset is issued by the driver on USB2 Host Port0 or USB2 Host Port1 respectively.

Implication: When this erratum occurs, the traffic interruption on HSIC Port0 or Port1 will result in a transaction error being reported by the HSIC host controller to the driver. The driver in response will re-enumerate the HSIC device causing it to reset.

Workaround: Configure USB and HSIC ports such that USB Port0 in USB2 host mode is not used simultaneously with HSIC Port0, and USB Port1 in USB2 host mode is not used simultaneously with HSIC Port1.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT68 Frequency Reported by CPUID Instruction May Not Match Published Frequency**

Problem: When the CPUID instruction is executed with EAX = 80000002H, 80000003H, and 80000004H, the frequency reported in the brand string may be truncated while the published frequency is rounded. For example, a processor with a frequency of 1.4999GHz may be reported as 1.49GHz in the brand string instead of the published frequency of 1.5GHz.

Implication: Certain Intel® Atom™ Z3600 and Z3700 series processors may report in brand string a frequency lower than the published frequency.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT69 Machine Check Status Overflow Bit May Not be Set

Problem: The OVER (error overflow) indication in bit [62] of the IA32_MCO_STATUS MSR (401H) may not be set if IA32_MCO_STATUS.MCACOD (bits [15:0]) held a value of 0x3 (External Error) when a second machine check occurred in the MCO bank. Additionally, the OVER indication may not be set if the second machine check has an MCACOD value of 0x810, 0x820 or 0x410, regardless of the first error.

Implication: Software may not be notified that an overflow of MCO bank occurred.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT70 Attempts to Clear Performance Counter Overflow Bits May Not Succeed

Problem: An MSR write which sets IA32_PERF_GLOBAL_OVF_CTRL MSR (390H) bits 1 and/or 0 may not clear the corresponding bit(s) of IA32_PERF_GLOBAL_STATUS MSR (38EH) if neither IA32_PMC0 nor IA32_PMC1 are enabled at the time of the MSR write and at least one of the fixed-function performance counters is enabled.

Implication: Software will not be able to rely on writes to this MSR to clear the overflow indication of the general-purpose performance counters.

Workaround: Software can avoid this erratum by disabling all fixed-function performance counters before writing to IA32_PERF_GLOBAL_OVF_CTRL MSR.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT71 SMI in 64 Bit Mode May Store an Incorrect RIP to SMRAM When CS has a Non-Zero Base

Problem: On an SMI (system-management interrupt), the processor stores the RIP of the next instruction in SMRAM (system-management RAM). Due to this erratum, an SMI that occurs while the processor is in 64-bit mode with a non-zero value in the CS segment base may result in an incorrect RIP being stored in SMRAM.

Implication: When this erratum occurs, the RIP stored in SMRAM will be incorrect and the RSM instruction will resume from that incorrect RIP, resulting in unpredictable system behavior. Intel has not observed this erratum with any commercially available system.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT72 VM Exit May Set IA32_EFER.NXE When IA32_MISC_ENABLE Bit 34 is Set to 1

Problem: When “XD Bit Disable” in the IA32_MISC_ENABLE MSR (1A0H) bit 34 is set to 1, it should not be possible to enable the “execute disable” feature by setting IA32_EFER.NXE. Due to this erratum, a VM exit that occurs with the 1-setting of the “load IA32_EFER” VM-exit control may set IA32_EFER.NXE even if IA32_MISC_ENABLE bit 34 is set to 1. This erratum can occur only if IA32_MISC_ENABLE bit 34 was set by guest software in VMX non-root operation.

Implication: Software in VMX root operation may execute with the “execute disable” feature enabled despite the fact that the feature should be disabled by the IA32_MISC_ENABLE MSR. Intel has not observed this erratum with any commercially available software.

Workaround: A virtual-machine monitor should not allow guest software to write to the IA32_MISC_ENABLE MSR.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT73 Top Swap Mechanism May Become Incorrectly Configured

Problem: Writing the General Control Register may cause the top swap mechanism to become incorrectly configured, resulting in unreliable boot behavior.

Implication: Due to this erratum, boot behavior may become unreliable which may impact system availability.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT74** **Certain Peripheral I/O Controllers May Hang After an Unexpectedly Long Latency Memory Transaction**

Problem: When an eMMC (Embedded MultiMedia Card), LPE (Low Power Engine), xHCI (USB Device Mode Controller), SDIO (Secure Digital Input Output), or SD (Secure Digital) controller memory transaction encounters an unexpectedly long latency, this may cause the controller to hang.

Implication: When this erratum occurs, the peripheral I/O controller will hang.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT75 **Disabling SDIO or SDCARD May Lead To a System Hang**

Problem: If BIOS disables either the SDIO or the SDCard (but not both) and follows the recommended sequence of placing the disabled controller in D3, the remaining enabled controller may stop functioning and hang the system. If BIOS doesn't put the disabled controller in D3, the enabled controller will operate normally but entry to the S0ix low-power state is blocked.

Implication: When this erratum occurs, the SDIO or the SDCARD stops functioning and may hang the system.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT76 **System May Hang When Attempting to Exit an S0ix Idle State**

Problem: Due to the erratum, a complex set of micro-architectural conditions may cause a hang when attempting to resume to S0 state from an S0ix Idle state.

Implication: When this erratum occurs, the SoC will become non-responsive until a power cycle occurs.

Workaround: A BIOS code change has been identified and may be implemented as a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT77 **TLB Entries May Not Be Invalidated Properly When Bit 8 Is Set in EPT Paging-Structure Entries**

Problem: EPT (extended page tables) translates guest-physical addresses to physical addresses using EPT paging structures. Bit 8 of each EPT paging-structure entry is available to software and should be ignored by the processor. Due to this erratum, the INVPID and MOV to CR3 instructions may fail to invalidate TLB entries that were created using EPT paging-structure entries in which bit 8 was set.

Implication: The affected TLB entries may be incorrectly shared across linear-address spaces, possibly leading to unpredictable guest behavior.

Workaround: It is possible for the firmware to contain a workaround for this erratum.



Status: For the steppings affected, see the Summary Tables of Changes.

VLT78 System May Hang During Entry to S0ix

Problem: During entry into S0ix state, complex internal conditions may lead to a hang.

Implication: When this erratum occurs, an attempt to enter an S0ix state will result in a system hang.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT79 CPUID Instruction Leaf 0AH May Return an Unexpected Value

Problem: When a CPUID instruction is executed with EAX = 0AH (Architectural Performance Monitoring Leaf), the value returned in EDX may incorrectly set bit 14. CPUID leaf 0AH EDX bit 14 is reserved and should be zero.

Implication: When this erratum occurs, the processor will report an incorrect value in EDX.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT80 VM Exits During Execution of INTn in Virtual-8086 Mode with Virtual-Mode Extensions May Save RFLAGS Incorrectly

Problem: An APIC-access VM exit or a VM exit due to an EPT (Extended Page Table) violation or an EPT misconfiguration that occurs during execution of the INTn instruction in virtual-8086 mode (EFLAGS.VM = 1) with virtual-mode extensions (CR4.VME = 1) may save an incorrect value for RFLAGS in the guest-state area of the VMCS.

Implication: Saving an incorrect value for RFLAGS may cause a virtual-machine monitor to handle the VM exit incorrectly, may cause a subsequent VM entry to fail; or may cause incorrect operation of guest software.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT81 Clearing IA32_MCO_CTL[5] May Prevent Machine Check Notification

Problem: Clearing bit 5 of a logical processor's IA32_MCO_CTL MSR (400H) may incorrectly block notifying other logical processors of any local machine check.

Implication: The system may not react as expected to a machine check exception when IA32_MCO_CTL[5] is 0.

Workaround: None identified.

Status: For the steppings affected, see the Summary Tables of Changes.

**VLT82 System May Unexpectedly Reboot After Shutdown**

Problem: Certain internal conditions may cause the system to reboot immediately after a shutdown.

Implication: A user shutdown request may not result in the system reaching a power-off condition.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

VLT83 APIC Timer Interrupt May Not Wake The System From CS

Problem: In certain cases, an APIC timer interrupt may not cause the SoC to awake from CS (Connected Standby).

Implication: When this erratum occurs, the SoC may continue to stay in CS until a different wake event (such as the power button or a USB wake) occurs or, if the PMC (Power Management Controller) watchdog timer is enabled, the platform may be reset.

Workaround: It is possible for the firmware to contain a workaround for this erratum.

Status: For the steppings affected, see the Summary Tables of Changes.

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Specification Changes

There are no specification changes in this revision of the Specification Update.

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Specification Clarifications

VLT1 Top Swap Feature

Due to Erratum VLT73 "Top Swap Mechanism May Become Incorrectly configured" the Top Swap capability is de-featured. Affected documents are:

- Intel® Atom™ Processor Z3600 and Z3700 Series Datasheet (Volume 1 of 2)

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Documentation Changes

There are no documentation changes in this revision of the Specification Update.

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